		Aces P/N: 55928 series							
TITLE: USB 3.0 A TYPE									
DELEVEE DVIE: 3030 04 30	DEMISION: D		ECN No: ECN 2004170	DAGE: 1 OF 0					

2 SCOPE

This specification covers performance, tests and quality requirements for USB 3.0 connector.

3 APPLICABLE DOCUMENTS

EIA-364: **ELECTRONICS INDUSTRIES ASSOCIATION**

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy

Finish: (a) Contact Area: Refer to the drawing.

- (b) Under plate: Refer to the drawing.
- (c) Solder area: Refer to the drawing.
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp.
- 4.2.3 Shell: Refer to the drawing.
- 4.3 Ratings
 - 4.3.1 Voltage: 30 Volts AC (per pin)
 - 4.3.2 Current: 1.8 A FOR PIN 1 AND PIN 4
 - 0.25A FOR ALL THE OTHER CONTACTS
 - 4.3.3 Operating Temperature : -55°C to +85°C

		Aces P/N: 5	5928 series	
TITLE: USB 3.0 A TYPE				
RELEASE DATE: 2020.04.29	REVISION: D		ECN No: ECN-2004170	PAGE: 5 OF 9

5 Performance

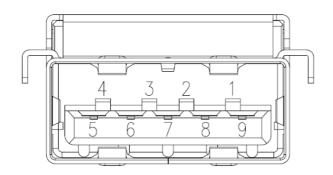
5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.					
	ELECTRICAL						
ltem	Requirement	Standard					
Low Level Contact Resistance	 30 mΩ (Max) initial for VBUS and GND contacts. 50 mΩ (Max) initial for all other contacts. 40 mΩ (Max) after for VBUS and GND contacts. 60 mΩ (Max) after for all other contacts. 	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance 100 M Ω Min.		Unmated and mated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)					
Dielectric withstanding voltage No discharge, flashover or breakdown. Current leakage: 1 mA max.		100 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated and mated connectors. (EIA-364-20)					
Temperature rise 30°C Max. Change allowed		A current of 1.8 A shall be applied to VBUS pin and its corresponding GND pin. Additionally, a minimum current of 0.25 A shall be applied to all tile other contacts. when measured at an ambient temperature of 25 °C. (EIA-364-70 METHOD 2)					
Differential Impedance	90Ω +/-15Ω Reefer to High Frequency Graphic Figure 1	Mated connector 50 ps (20%-80%) Risetime.					
MECHANICAL							
Item	Requirement	Standard					
Durability 5000 cycles.		The durability test shall be done at a maximum rate of 200 cycles per hour and no physical damage to any part of the connector and cable assembly shall occur. (EIA-364-09)					

	Aces P/I	N: 55928 se	ries	
: USB 3.0 A TYPE	I			
E DATE: 2020.04.29	REVISION: D	ECN No: E0	CN-2004170	PAGE: 6 OF
		1		
Insertion / Extraction F	orce Insertion Force: 25 Extraction Force: 10 N~25N (initial) 8 N~25N (after test		Operation Speed 12.5 ± 3 mm/min Measure the forc mate/unmate cor (EIA-364-13)	ute ce required to
Vibration	1 μs Max.		be 100 mA maxil contacts. Subject harmonic motion of 0.76mm (1.52 total excursion) i between the limit. The entire freques 10 to 55 Hz and shall be traverse 1 minute. This napplied for 2 hou mutually perpend (EIA-364-28 Cor	to a simple having amplitude mm maximum n frequency ts of 10 and 55 Hz. ency range, from return to 10 Hz, d in approximately notion shall be urs in each of three dicular directions.
	ENVIRO	NMENTAI	<u>_</u>	
Item Resistance to Reflox Soldering Heat	Require See Product Qualifi Sequence Group 8	ication and Test	Pre Heat : 150°C 60~120sec. Heat : 230°C Mir Peak Temp. : 26	n., 40sec Min.
Thermal Shock	See Product Qualif Sequence Group 4		Mate module and condition for 5 cy	minutes minutes
Humidity	See Product Qualif Sequence Group 4		Mated Connecto 40°C, 90~95% R 96 hours. (EIA-364-31,Cond	Н,
Temperature life	See Product Qualif Sequence Group 5		Subject mated contemperature life hours. (EIA-364-17, Tes	at 105°C for 96
Salt Spray	See Product Qualif Sequence Group 6		concentration, 35 (EIA-364-26)	% salt-solution 5°C,48 hours
Solder ability	Solder able area sh		And then into so Temperature at 2 sec. (EIA-364-5)	245 ±5°C, for 5

		Aces P/N: 55928 series					
TITLE: USB 3.0 A TYPE							
RELEASE DATE: 2020.04.29	REVISION: D		ECN No: ECN-2004170	PAGE: 7 OF 9			

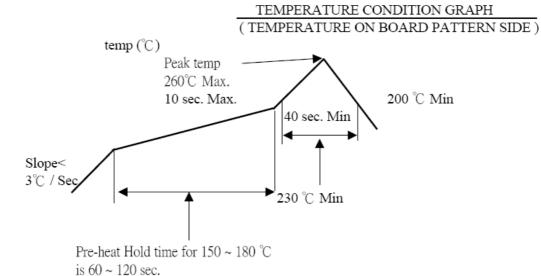
6 PIN ASSIGNMENTS



Schematic diagram

Pin Number	Signal Name				
1	VBUS				
2	D-				
3	D+				
4	GND				
5	StdA_SSRX-				
6	StdA_SSRX+				
7	GND_DRAIN				
8	StdA_SSTX-				
9	StdA_SSTX+				
Shell	Shield				

7 INFRARED REFLOW CONDITION



	Aces P/N: 55928 series					
TITLE: USB 3.0 A TYPE						
RELEASE DATE: 2020.04.29	REVISION: D		ECN No: ECN-2004170	PAGE: 8 OF 9		

8 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	10
				T	est Se	quenc	e			
Examination of Product				1 . 7	1、6	1 \ 4		1		
Low Level Contact Resistance		1 \ 5	1 \ 3	2 \ 10	2 \ 9	2 ` 5		3		
Insulation Resistance				3 . 9	3、8					
Dielectric Withstanding Voltage				4 · 8	4 · 7					
Temperature rise	1									
Insertion / Extraction Force		2 · 4								
Durability		3								
Vibration			2							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Resistance to Soldering Heat								2		
Sample Size	2	4	4	4	4	4	2	4		

